Unit: mm

TOSHIBA Photocoupler Photorelay

TLP3103

Measurement Equipment FA (Factory Automation) Power Line Control Security Systems

The Toshiba TLP3103 consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surfacemount assembly. The TLP3103 features high ON-state current and low ON-state resistance, hence the TLP3103 is suitable to control a power line.

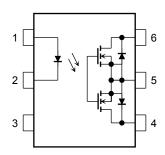
- 6-pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- Normally opened (form A) device
- Peak OFF-state voltage: 60 V (min)
- Trigger LED current: 3 mA (max)
- ON-state current: 2.3 A (max) (Ta=50°C)
- ON-state resistance: 0.04Ω (typ.), 0.07Ω (max)
- Capacitance between output terminals: 1000 pF (typ.)
- OFF-state current: 10 nA (max)
- Isolation voltage: 1500 V_{rms} (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A

File No.E67349

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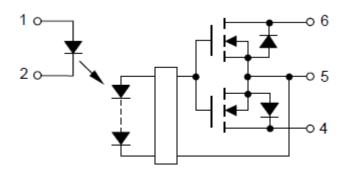
Weight: 0.13 g (typ.)

Pin Configuration (top view)



- 1: Anode
- 2: Cathode
- 3: N.C.
- 4: Drain D1
- 5: Source
- 6: Drain D2

Schematic



Start of commercial production 2010-06

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit		
LED	Forward current		lF	30	mA	
	Forward current derating (Ta ≥ 25°C)		ΔI _F /°C	-0.3	mA/°C	
	Reverse voltage		VR	5	V	
	Diode power dissipation		P _D	50	mW	
	Diode power dissipation derating (Ta ≥25°C)		ΔP _D /°C	-0.5	mW/°C	
	Junction tem	perature	Tj	125	°C	
	Off-state out	put terminal voltage	Voff	60	V	
	On-state current	A connection		2.3		
		B connection	ION	2.3	Α	
		C connection		4.6		
	Forward current derating (Ta ≥ 50°C)	A connection		-30.7		
		B connection	Δl _{ON} /°C	-30.7	mA/°C	
Detector		C connection		-61.3		
	On-state current (pulsed) (t = 100 ms)		IONP	7	Α	
	Output power dissipation		Ро	370	mW	
	Output power dissipation derating (Ta ≥ 50°C)		ΔP _O /°C	-4.94	mW / °C	
	Junction tem	perature	Tj	125	°C	
Storage to	Storage temperature			−55 to 125	°C	
Operating	Operating temperature			−40 to 85	°C	
Lead sold	Lead soldering temperature (10 s)			260	°C	
Isolation	solation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)			1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: Pins 1 and 2 shorted together, and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

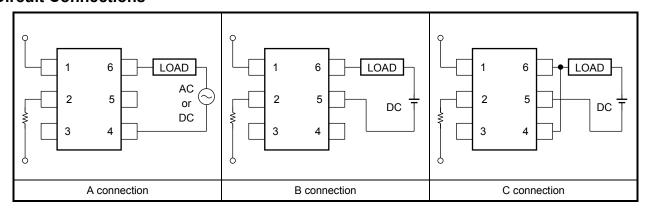
Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{DD}	_	_	60	V
Forward current	lF	_	7.5	20	mA
Operating temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

TLP3103



Circuit Connections



Individual Electrical Characteristics (Ta = 25°C)

	Characteristics		Test Condition	Min	Тур.	Max	Unit
	Forward current	VF	I _F = 10 mA	1.18	1.33	1.48	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μА
	Capacitance between terminals	CT	V _F = 0 V, f = 1 MHz	_	70	_	pF
Detector	OFF-state current	loff	V _{OFF} = 60 V	_	_	10	nA
Dete	Capacitance between terminals	C _{OFF}	V = 0 V, f = 1 MHz	ı	1000	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		lfT	I _{ON} = 100 mA	_	0.4	3	mA
Return LED current		IFC	IOFF = 10 μA	0.1	_	_	mA
	A connection		ION = 2.0 A, IF = 5 mA, t<1 s	_	0.04	0.07	
On-state resistance	B connection	Ron	ION = 2.0 A, IF = 5 mA, t<1 s	_	0.02	0.04	Ω
	C connection		ION = 4.0 A, IF = 5 mA, t<1 s	_	0.01	_	

Isolation Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVs	AC, 60 s	1500	_	_	Vrms

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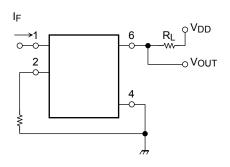
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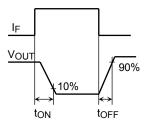


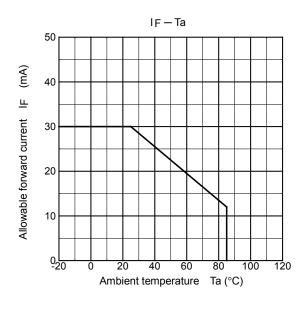
Switching Characteristics (Ta = 25°C)

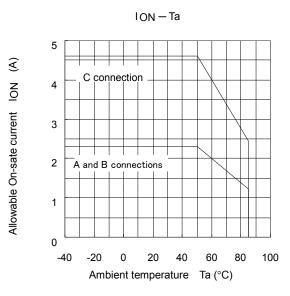
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-ON time	toN	$R_L = 200 \Omega$	_	1.0	5.0	
Turn-OFF time	toff	$V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA}$ (Note	2) —	0.15	1.0	
Turn-ON time	ton	R _L = 200 Ω	_	0.5	3.0	ms
Turn-OFF time	toff	$V_{DD} = 20 \text{ V, IF} = 10 \text{ mA}$ (Note	2) —	0.15	1.0	

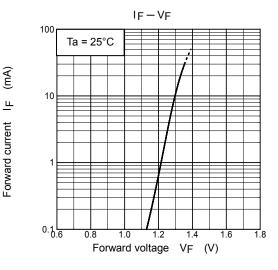
Note 2: Switching time test circuit

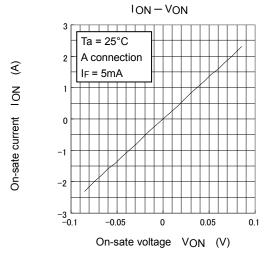


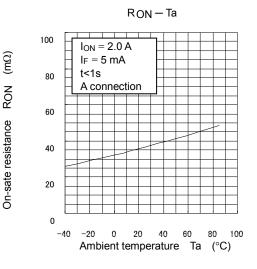


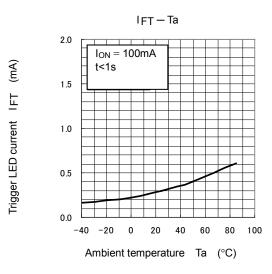




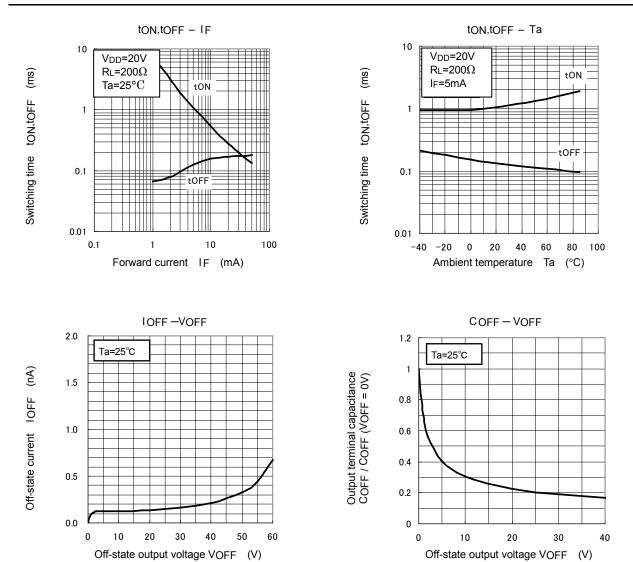








NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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